

# MICRO SIM CARD SOCKET PUSH-PUSH TYPE



## 5560 SERIES. Micro Sim Card Socket 6 contacts.

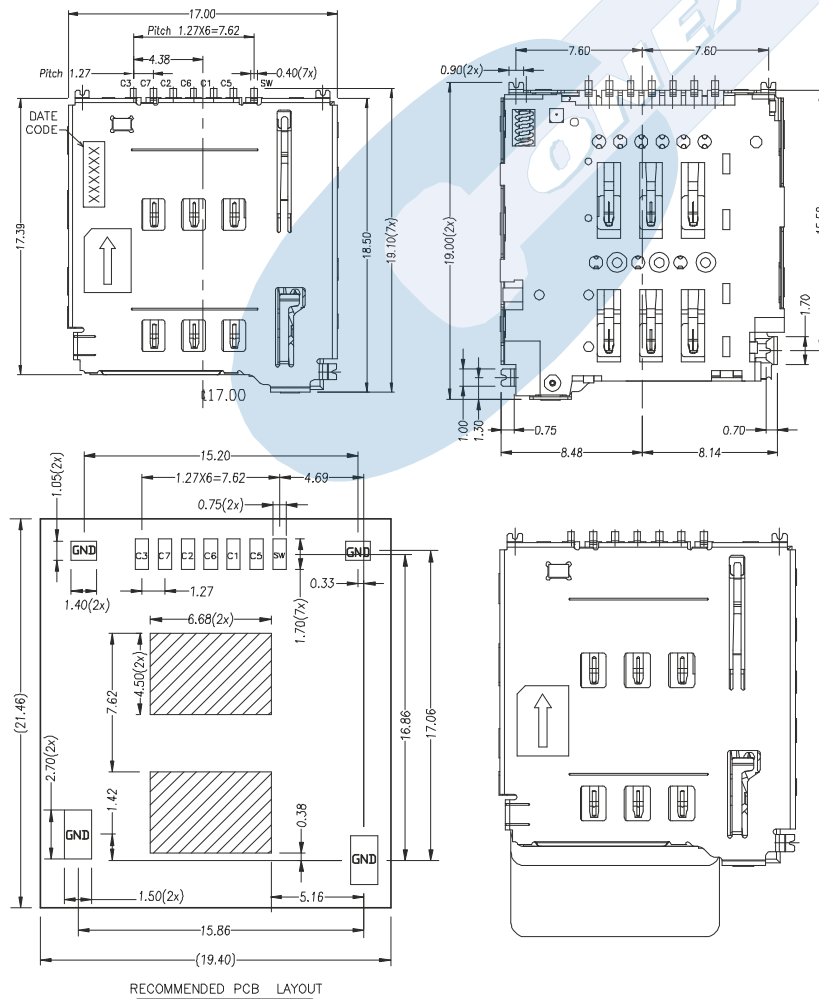
### General Features

- Available in 6 contacts
- Accept Micro SIM card 6 contact
- Contact area: different gold plating over 50 μ nickel
- Solder area: 100μ tin plating over 50 μ nickel
- Stand-off: 0 mm. With SMT fixing tabs.
- With card detect

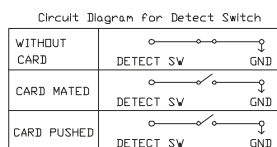
### Materials

- Insulator: high temperature thermoplastic UL 94 V-0
- Contact: Brass
- Switch terminal: brass
- Shell: SUS304 t=0.20 mm.
- Operating temperature. -25°C to +85°C
- RoHS compliant

### Dimensional Information



SIM CARD Distribution Pin							
C1	C2	C3	C4	C5	C6	C7	C8
VCC	RST	CLK	Reser.	GND	VPP	I/O	Reser.

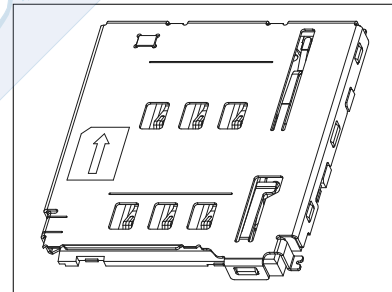


### Electrical Features

- Voltage rating: < 30 V
- Current rating: < 0.50 A
- Contact resistance: < 30 mΩ
- Dielectric withstanding voltage: 500 V AC/minute
- Insulation resistance: >1000 MΩ

### Mechanical Features

- Contact retention force: > 0.10 Kgf
- Insertion force: < 0.70 Kgf
- Withdrawal force: >0.026 Kgf
- Durability: 10.000 cycles



## 5560 - T- XX- E

1 2 3 4

### 1. Series

### 2. Plating Options

- T = 3. Gold flash over nickel  
Recommended Finish

### 3. Number of circuits

- Available in 06 circuits

### 4. Packing Options

- E = 2. Reel

